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FFP08H60S 8 A, 600 V, Hyperfast II Diode

Features

- Hyperfast Recovery t_{rr} = 45 ns (@ I_F = 8 A)
- Max Forward Voltage, V_F = 2.6 V (@ T_C = 25°C)
- · 600 V Reverse Voltage and High Reliability
- · Avalanche Energy Rated
- · RoHS Compliant

Applications

- · General Purpose
- · SMPS, Power Switching Circuits
- · Free-Wheeling Diode for Motor Application

Description

The FFP08H60S is a hyperfast II diode and silicon nitride passivated ion-implanted epitaxial planar construction.

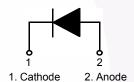
This device is intended for use as freewheeling/clamping diodes in a variety of switching power supplies and other power switching applications. Its low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

Pin Assignments



1. Cathode

2. Anode



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Unit
V _{RRM}	Peak Repetitive Reverse Voltage	600	V
V _{RWM}	Working Peak Reverse Voltage	600	V
V_R	DC Blocking Voltage	600	V
I _{F(AV)}	Average Rectified Forward Current @ T _C = 105 °C	8	Α
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	60	А
$T_{J_i}T_{STG}$	Operating Junction and Storage Temperature	- 65 to +175	°C

Thermal Characteristics T_C = 25°C unless otherwise noted

Symbol	Parameter	Max.	Unit	
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	2.5	°C/W	

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FFP08H60STU	F08H60S	TO-220-2L	Tube	N/A	N/A	50

Electrical Characteristics T_C = 25°C unless otherwise noted

Parameter	Conditions			Тур.	Max.	Unit
V _F ¹	I _F = 8 A	T _C = 25 °C	-	-	2.1	٧
	I _F = 8 A	T _C = 125 °C	-	-	1.7	V
I_R^1	V _R = 600 V	T _C = 25 °C	-	-	100	μΑ
	V _R = 600 V	T _C = 125 °C	-	1	200	μΑ
t _{rr}	$I_F = 1 \text{ A, di}_F/\text{dt} = 100 \text{ A/}\mu\text{s, V}_R = 30 \text{ V}$	T _C = 25 °C	-	-	35	ns
	$I_F = 8 \text{ A}, di_F/dt = 100 \text{ A/}\mu\text{s}, V_R = 390 \text{ V}$	T _C = 25 °C	-	1	45	ns
t _a	$I_F = 8 \text{ A}, \text{ di}_F/\text{dt} = 100 \text{ A/}\mu\text{s}, V_R = 390 \text{ V}$	T _C = 25 °C	-	15	-	ns
t _b		T _C = 25 °C	-	16	-	ns
Q _{rr}		T _C = 25 °C	-	18.6	-	nC
W _{AVL}	Avalanche Energy (L = 40 mH)		20	-	-	mJ

Notes:

1. Pulse : Test Pulse width = $300\mu s$, Duty Cycle = 2%

Test Circuit and Waveforms

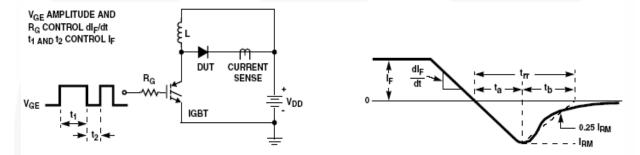


Figure 1. Diode Reverse Recovery Test Circuit & Waveform

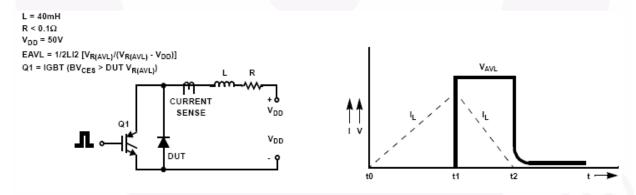


Figure 2. Unclamped Inductive Switching Test Circuit & Waveform

Typical Performance Characteristics T_C = 25°C unless otherwise noted

Figure 3. Typical Forward Voltage Drop

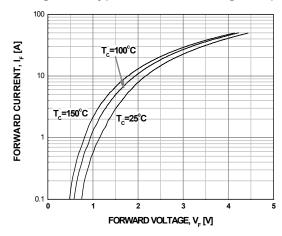


Figure 4. Typical Reverse Current

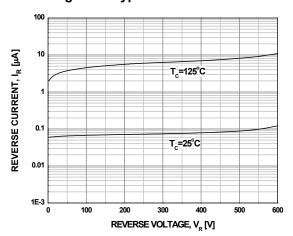


Figure 5. Typical Junction Capacitance

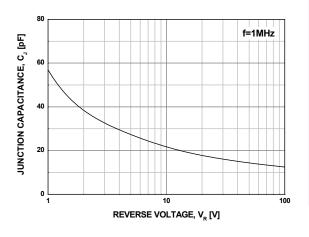


Figure 6. Typical Reverse Recovery Time

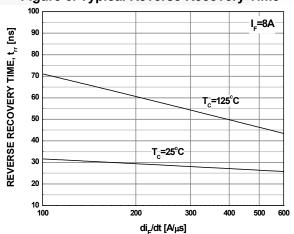


Figure 7. Typical Reverse Recovery Current

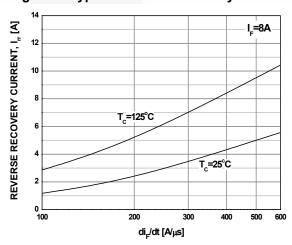
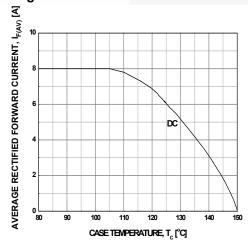
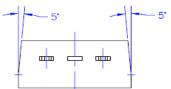


Figure 8. Forward Current Deration Curve



◆ 0.36M B AM 10.67 9.65 3.43 2.54 6.86 13.40 12.19 9.40 2 1.78 MAX 6.35 MAX С 14.73 12.70 (1.91) -2.54 ♦ 0.38M B AM 5.08 NOTES: UNLESS OTHERWISE SPECIFIED



Mechanical Dimensions

- REFERENCE JEDEC, TO-220, ISSUE K, VARIATION AC, DATED APRIL 2002.
- B)
- ALL DIMENSIONS ARE IN MILLIMETERS.
 DIMENSIONS ARE INCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS. C)
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5 - 1973
 PRESENCE OF TRIMMED CENTER LEAD
- IS OPTIONAL

Figure 9. TO-220 2L - 2LD, TO220, JEDEC TO-220 VARIATION AC

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Definition of Terms

Datasheet Identification Product Status		Definition
Advance Information Formative / In Design		Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

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